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Details

Product Status	Active
Core Processor	HCS12X
Core Size	16-Bit
Speed	50MHz
Connectivity	CANbus, EBI/EMI, I ² C, IrDA, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	59
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	1.72V ~ 5.5V
Data Converters	A/D 12x12b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-QFP
Supplier Device Package	80-QFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc9s12xeq512caa

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The resulting timing pattern of the external bus signals is outlined in the following tables for read, write and interleaved read/write accesses. Three examples represent different access lengths of 1, 2, and n–1 bus cycles. Non-shaded bold entries denote all values related to Access #0.

The following terminology is used:

- 'addr' --- value(ADDRx); small letters denote the logic values at the respective pins
- 'x' Undefined output pin values
- 'z' Tristate pins
- "." Dependent on previous access (read or write); IVDx: "ivd" or "x"; DATAx: "data" or "z"

5.4.2.4.1 Read Access Timing

			Acce	ss #0		Acce	ss #1	
Bus cycle ->	1 2		:	3				
ECLK phase		high	low	high	low	high	low	
ADDR[22:20] / ACC[2:0]			acc 0		acc 1		acc 2	
ADDR[19:16] / IQSTAT[3:0]		addr 0 iqstat -1		addr 1	iqstat 0	addr 2	iqstat 1	
ADDR[15:0] / IVD[15:0]			?		ivd 0		ivd 1	
DATA[15:0] (internal read)		?	z	z	z	z	z	
DATA[15:0] (external read)		?	z	data 0	Z	data 1	Z	
RW		1	1	1	1	1	1	

Table 5-12. Read Access (1 Cycle)

Table 5-13. Read Access (2 Cycles)

			Acce	ss #0		Access #1			
Bus cycle ->	1 2		:	3					
ECLK phase		high	low	high	low	high	low		
ADDR[22:20] / ACC[2:0]			acc 0		000		acc 1		
ADDR[19:16] / IQSTAT[3:0]		addr 0 iqstat-1		addr 0	iqstat 0	addr 1	0000		
ADDR[15:0] / IVD[15:0]			?		x		ivd 0		
DATA[15:0] (internal read)		?	z	z	z	z	z		
DATA[15:0] (external read)		?	z	z	z	data 0	z		
RW		1	1	1	1	1	1		

Table 5-14. Read Access (n–1 Cycles)

			Acce							
Bus cycle ->	 1 2 3				3		r	า		
ECLK phase	 high	low	high	low	high	low		high	low	
ADDR[22:20] / ACC[2:0]		acc 0		000		000			acc 1	
ADDR[19:16] / IQSTAT[3:0]	 addr 0	iqstat-1	addr 0	iqstat 0	addr 0	0000		addr 1	0000	
ADDR[15:0] / IVD[15:0]		?		x		x			ivd 0	
DATA[15:0] (internal read)	 ?	z	z	z	z	z		z	z	



8.4.7.1 XGATE Software Breakpoints

The XGATE software breakpoint instruction BRK can request a CPU12X breakpoint, via the S12XDBG module. In this case, if the XGSBPE bit is set, the S12XDBG module immediately generates a forced breakpoint request to the CPU12X, the state sequencer is returned to state0 and tracing, if active, is terminated. If configured for BEGIN trigger and tracing has not yet been triggered from another source, the trace buffer contains no information. Breakpoint requests from the XGATE module do not depend upon the state of the DBGBRK or ARM bits in DBGC1. They depend solely on the state of the XGSBPE and BDM bits. Thus it is not necessary to ARM the DBG module to use XGATE software breakpoints to generate breakpoints in the CPU12X program flow, but it is necessary to set XGSBPE. Furthermore, if a breakpoint to BDM is required, the BDM bit must also be set. When the XGATE requests an CPU12X breakpoint, the XGATE program flow stops by default, independent of the S12XDBG module.

8.4.7.2 Breakpoints From Internal Comparator Channel Final State Triggers

Breakpoints can be generated when internal comparator channels trigger the state sequencer to the Final State. If configured for tagging, then the breakpoint is generated when the tagged opcode reaches the execution stage of the instruction queue.

If a tracing session is selected by TSOURCE, breakpoints are requested when the tracing session has completed, thus if Begin or Mid aligned triggering is selected, the breakpoint is requested only on completion of the subsequent trace (see Table 8-48). If no tracing session is selected, breakpoints are requested immediately.

If the BRK bit is set on the triggering channel, then the breakpoint is generated immediately independent of tracing trigger alignment.

BRK	TALIGN	DBGBRK[n]	Breakpoint Alignment
0	00	0	Fill Trace Buffer until trigger (no breakpoints — keep running)
0	00	1	Fill Trace Buffer until trigger, then breakpoint request occurs
0	01	0	Start Trace Buffer at trigger (no breakpoints — keep running)
0	01	1	Start Trace Buffer at trigger A breakpoint request occurs when Trace Buffer is full
0	10	0	Store a further 32 Trace Buffer line entries after trigger (no breakpoints — keep running)
0	10	1	Store a further 32 Trace Buffer line entries after trigger Request breakpoint after the 32 further Trace Buffer entries
1	00,01,10	1	Terminate tracing and generate breakpoint immediately on trigger
1	00,01,10	0	Terminate tracing immediately on trigger
x	11	x	Reserved

Table 0-40. Dieakpoint Setup I of Doth AGATE and OF 012A Dieakpoints	Table 8	8-48. E	Breakpoin	t Setup	For	Both	XGATE	and	CPU12X	Breakpo	ints
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9.1.4.2 Special Single Chip Mode (SS)

- BDM firmware commands are disabled.
- BDM hardware commands are restricted to the register space.
- Execution of Flash and EEPROM commands is restricted. Please refer to the NVM block guide for details.
- Tracing code execution using the DBG module is disabled.
- Debugging XGATE code (breakpoints, single-stepping) is disabled.

Special single chip mode means BDM is active after reset. The availability of BDM firmware commands depends on the security state of the device. The BDM secure firmware first performs a blank check of both the Flash memory and the EEPROM. If the blank check succeeds, security will be temporarily turned off and the state of the security bits in the appropriate Flash memory location can be changed If the blank check fails, security will remain active, only the BDM hardware commands will be enabled, and the accessible memory space is restricted to the peripheral register area. This will allow the BDM to be used to erase the EEPROM and Flash memory without giving access to their contents. After erasing both Flash memory and EEPROM, another reset into special single chip mode will cause the blank check to succeed and the options/security byte can be programmed to "unsecured" state via BDM.

While the BDM is executing the blank check, the BDM interface is completely blocked, which means that all BDM commands are temporarily blocked.

9.1.4.3 Expanded Modes (NX, ES, EX, and ST)

- BDM operation is completely disabled.
- Internal Flash memory and EEPROM are disabled.
- Execution of Flash and EEPROM commands is restricted. Please refer to the FTM block guide for details.
- Tracing code execution using the DBG module is disabled.
- Debugging XGATE code (breakpoints, single-stepping) is disabled

9.1.5 Unsecuring the Microcontroller

Unsecuring the microcontroller can be done by three different methods:

- 1. Backdoor key access
- 2. Reprogramming the security bits
- 3. Complete memory erase (special modes)

9.1.5.1 Unsecuring the MCU Using the Backdoor Key Access

In normal modes (single chip and expanded), security can be temporarily disabled using the backdoor key access method. This method requires that:

• The backdoor key at 0xFF00–0xFF07 (= global addresses 0x7F_FF00–0x7F_FF07) has been programmed to a valid value.



Table 10-23. Access Detail Notation

- v --- Vector fetch: always an aligned word read, lasts for at least one RISC core cycle
- P Program word fetch: always an aligned word read, lasts for at least one RISC core cycle
- r 8 bit data read: lasts for at least one RISC core cycle
- R 16 bit data read: lasts for at least one RISC core cycle
- $_{\rm W}$ 8 bit data write: lasts for at least one RISC core cycle
- w 16 bit data write: lasts for at least one RISC core cycle
- A Alignment cycle: no read or write, lasts for zero or one RISC core cycles
- ${\rm f}$ Free cycle: no read or write, lasts for one RISC core cycles

Special Cases

PP/P - Branch: PP if branch taken, P if not

10.8.4 Thread Execution

When the RISC core is triggered by an interrupt request (see Figure 10-1) it first executes a vector fetch sequence which performs three bus accesses:

- 1. A V-cycle to fetch the initial content of the program counter.
- 2. A V-cycle to fetch the initial content of the data segment pointer (R1).
- 3. A P-cycle to load the initial opcode.

Afterwards a sequence of instructions (thread) is executed which is terminated by an "RTS" instruction. If further interrupt requests are pending after a thread has been terminated, a new vector fetch will be performed. Otherwise the RISC core will either resume a previous thread (beginning with a P-cycle to refetch the interrupted opcode) or it will become idle until a new interrupt request is received. A thread can only be interrupted by an interrupt request of higher priority.

10.8.5 Instruction Glossary

This section describes the XGATE instruction set in alphabetical order.



Chapter 10 XGATE (S12XGATEV3)

Branch if Carry Cleared (Same as BHS)



Operation

If C = 0, then $PC + $0002 + (REL9 \le 1) \Rightarrow PC$

Tests the Carry flag and branches if C = 0.

CCR Effects

Ν	Z	V	С
_	—	—	—

- N: Not affected.
- Z: Not affected.
- V: Not affected.
- C: Not affected.

Code and CPU Cycles

Source Form	Address Mode	Machine Code						Cycles		
BCC REL9	REL9	0	0	1	0	0	0	0	REL9	PP/P



NEG

Two's Complement

NEG

Operation

- $-RS \Rightarrow RD$ (translates to SUB RD, R0, RS)
- $-RD \Rightarrow RD$ (translates to SUB RD, R0, RD)

Performs a two's complement on a general purpose register.

CCR Effects

Ν	Ζ	V	С
Δ	Δ	Δ	Δ

- N: Set if bit 15 of the result is set; cleared otherwise.
- Z: Set if the result is \$0000; cleared otherwise.
- V: Set if a two's complement overflow resulted from the operation; cleared otherwise. RS[15] & RD[15]_{new}
- C: Set if there is a carry from the bit 15 of the result; cleared otherwise $RS[15] \mid RD[15]_{new}$

Code and CPU Cycles

Source Form	Address Mode						Machin	ne Code				Cycles
NEG RD, RS	TRI	0	0	0	1	1	RD	0 0 0	RS	0	0	Р
NEG RD	TRI	0	0	0	1	1	RD	0 0 0	RD	0	0	Р



				RTR	6:4] =			
RTR[3:0]	000 (OFF)	001 (2 ¹⁰)	010 (2 ¹¹)	011 (2 ¹²)	100 (2 ¹³)	101 (2 ¹⁴)	110 (2 ¹⁵)	111 (2 ¹⁶)
0001 (÷2)	OFF	2x2 ¹⁰	2x2 ¹¹	2x2 ¹²	2x2 ¹³	2x2 ¹⁴	2x2 ¹⁵	2x2 ¹⁶
0010 (÷3)	OFF	3x2 ¹⁰	3x2 ¹¹	3x2 ¹²	3x2 ¹³	3x2 ¹⁴	3x2 ¹⁵	3x2 ¹⁶
0011 (÷4)	OFF	4x2 ¹⁰	4x2 ¹¹	4x2 ¹²	4x2 ¹³	4x2 ¹⁴	4x2 ¹⁵	4x2 ¹⁶
0100 (÷5)	OFF	5x2 ¹⁰	5x2 ¹¹	5x2 ¹²	5x2 ¹³	5x2 ¹⁴	5x2 ¹⁵	5x2 ¹⁶
0101 (÷6)	OFF	6x2 ¹⁰	6x2 ¹¹	6x2 ¹²	6x2 ¹³	6x2 ¹⁴	6x2 ¹⁵	6x2 ¹⁶
0110 (÷7)	OFF	7x2 ¹⁰	7x2 ¹¹	7x2 ¹²	7x2 ¹³	7x2 ¹⁴	7x2 ¹⁵	7x2 ¹⁶
0111 (÷8)	OFF	8x2 ¹⁰	8x2 ¹¹	8x2 ¹²	8x2 ¹³	8x2 ¹⁴	8x2 ¹⁵	8x2 ¹⁶
1000 (÷9)	OFF	9x2 ¹⁰	9x2 ¹¹	9x2 ¹²	9x2 ¹³	9x2 ¹⁴	9x2 ¹⁵	9x2 ¹⁶
1001 (÷10)	OFF	10x2 ¹⁰	10x2 ¹¹	10x2 ¹²	10x2 ¹³	10x2 ¹⁴	10x2 ¹⁵	10x2 ¹⁶
1010 (÷11)	OFF	11x2 ¹⁰	11x2 ¹¹	11x2 ¹²	11x2 ¹³	11x2 ¹⁴	11x2 ¹⁵	11x2 ¹⁶
1011 (÷12)	OFF	12x2 ¹⁰	12x2 ¹¹	12x2 ¹²	12x2 ¹³	12x2 ¹⁴	12x2 ¹⁵	12x2 ¹⁶
1100 (÷13)	OFF	13x2 ¹⁰	13x2 ¹¹	13x2 ¹²	13x2 ¹³	13x2 ¹⁴	13x2 ¹⁵	13x2 ¹⁶
1101 (÷14)	OFF	14x2 ¹⁰	14x2 ¹¹	14x2 ¹²	14x2 ¹³	14x2 ¹⁴	14x2 ¹⁵	14x2 ¹⁶
1110 (÷15)	OFF	15x2 ¹⁰	15x2 ¹¹	15x2 ¹²	15x2 ¹³	15x2 ¹⁴	15x2 ¹⁵	15x2 ¹⁶
1111 (÷16)	OFF	16x2 ¹⁰	16x2 ¹¹	16x2 ¹²	16x2 ¹³	16x2 ¹⁴	16x2 ¹⁵	16x2 ¹⁶

Table 11-10. RTI Frequency Divide Rates for RTDEC = 0

1. Denotes the default value out of reset. This value should be used to disable the RTI to ensure future backwards compatibility.

Table 11-11. RTI Frequency Divide Rates for RTDEC=1

		RTR[6:4] =										
RTR[3:0]	000 (1x10 ³)	001 (2x10 ³)	010 (5x10 ³)	011 (10x10 ³)	100 (20x10 ³)	101 (50x10 ³)	110 (100x10 ³)	111 (200x10 ³)				
0000 (÷1)	1x10 ³	2x10 ³	5x10 ³	10x10 ³	20x10 ³	50x10 ³	100x10 ³	200x10 ³				
0001 (÷2)	2x10 ³	4x10 ³	10x10 ³	20x10 ³	40x10 ³	100x10 ³	200x10 ³	400x10 ³				
0010 (÷3)	3x10 ³	6x10 ³	15x10 ³	30x10 ³	60x10 ³	150x10 ³	300x10 ³	600x10 ³				
0011 (÷4)	4x10 ³	8x10 ³	20x10 ³	40x10 ³	80x10 ³	200x10 ³	400x10 ³	800x10 ³				
0100 (÷5)	5x10 ³	10x10 ³	25x10 ³	50x10 ³	100x10 ³	250x10 ³	500x10 ³	1x10 ⁶				
0101 (÷6)	6x10 ³	12x10 ³	30x10 ³	60x10 ³	120x10 ³	300x10 ³	600x10 ³	1.2x10 ⁶				



ter 15 Inter-Integrated Circuit (IICV3) Block Description

transfer. In the broadcast, slaves always act as receivers. In general call, IAAS is also used to indicate the address match.

In order to distinguish whether the address match is the normal address match or the general call address match, IBDR should be read after the address byte has been received. If the data is \$00, the match is general call address match. The meaning of the general call address is always specified in the first data byte and must be dealt with by S/W, the IIC hardware does not decode and process the first data byte.

When one byte transfer is done, the received data can be read from IBDR. The user can control the procedure by enabling or disabling GCEN.

15.4.2 Operation in Run Mode

This is the basic mode of operation.

15.4.3 Operation in Wait Mode

IIC operation in wait mode can be configured. Depending on the state of internal bits, the IIC can operate normally when the CPU is in wait mode or the IIC clock generation can be turned off and the IIC module enters a power conservation state during wait mode. In the later case, any transmission or reception in progress stops at wait mode entry.

15.4.4 Operation in Stop Mode

The IIC is inactive in stop mode for reduced power consumption. The STOP instruction does not affect IIC register states.

15.5 Resets

The reset state of each individual bit is listed in Section 15.3, "Memory Map and Register Definition," which details the registers and their bit-fields.

15.6 Interrupts

IICV3 uses only one interrupt vector.

Table 15-12.	Interrupt	Summary
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Interrupt	Offset	Vector	Priority	Source	Description
IIC Interrupt				IBAL, TCF, IAAS bits in IBSR register	When either of IBAL, TCF or IAAS bits is set may cause an interrupt based on arbitration lost, transfer complete or address detect conditions

Internally there are three types of interrupts in IIC. The interrupt service routine can determine the interrupt type by reading the status register.

IIC Interrupt can be generated on

1. Arbitration lost condition (IBAL bit set)



19.4.2 PWM Channel Timers

The main part of the PWM module are the actual timers. Each of the timer channels has a counter, a period register and a duty register (each are 8-bit). The waveform output period is controlled by a match between the period register and the value in the counter. The duty is controlled by a match between the duty register and the counter value and causes the state of the output to change during the period. The starting polarity of the output is also selectable on a per channel basis. Shown below in Figure 19-19 is the block diagram for the PWM timer.



PWMEx



19.4.2.1 PWM Enable

Each PWM channel has an enable bit (PWMEx) to start its waveform output. When any of the PWMEx bits are set (PWMEx = 1), the associated PWM output signal is enabled immediately. However, the actual PWM waveform is not available on the associated PWM output until its clock source begins its next cycle due to the synchronization of PWMEx and the clock source. An exception to this is when channels are concatenated. Refer to Section 19.4.2.7, "PWM 16-Bit Functions" for more detail.

NOTE

The first PWM cycle after enabling the channel can be irregular.



1. The address bit identifies the frame as an address character. See Section 20.4.6.6, "Receiver Wakeup".

20.4.4 Baud Rate Generation

A 13-bit modulus counter in the baud rate generator derives the baud rate for both the receiver and the transmitter. The value from 0 to 8191 written to the SBR12:SBR0 bits determines the bus clock divisor. The SBR bits are in the SCI baud rate registers (SCIBDH and SCIBDL). The baud rate clock is synchronized with the bus clock and drives the receiver. The baud rate clock divided by 16 drives the transmitter. The receiver has an acquisition rate of 16 samples per bit time.

Baud rate generation is subject to one source of error:

• Integer division of the bus clock may not give the exact target frequency.

Table 20-16 lists some examples of achieving target baud rates with a bus clock frequency of 25 MHz.

When IREN = 0 then,

SCI baud rate = SCI bus clock / (16 * SCIBR[12:0])

Bits SBR[12:0]	Receiver Clock (Hz)	Transmitter Clock (Hz)	Target Baud Rate	Error (%)
41	609,756.1	38,109.8	38,400	.76
81	308,642.0	19,290.1	19,200	.47
163	153,374.2	9585.9	9,600	.16
326	76,687.1	4792.9	4,800	.15
651	38,402.5	2400.2	2,400	.01
1302	19,201.2	1200.1	1,200	.01
2604	9600.6	600.0	600	.00
5208	4800.0	300.0	300	.00

Table 20-16. Baud Rates (Example: Bus Clock = 25 MHz)

Table 22-6. TSCR1 Field Descriptions (continued)

Field	Description
4 TFFCA	 Timer Fast Flag Clear All Allows the timer flag clearing to function normally. For TFLG1(0x000E), a read from an input capture or a write to the output compare channel (0x0010–0x001F) causes the corresponding channel flag, CnF, to be cleared. For TFLG2 (0x000F), any access to the TCNT register (0x0004, 0x0005) clears the TOF flag. Any access to the PACNT registers (0x0022, 0x0023) clears the PAOVF and PAIF flags in the PAFLG register (0x0021). This has the advantage of eliminating software overhead in a separate clear sequence. Extra care is required to avoid accidental flag clearing due to unintended accesses.
3 PRNT	 Precision Timer 0 Enables legacy timer. PR0, PR1, and PR2 bits of the TSCR2 register are used for timer counter prescaler selection. 1 Enables precision timer. All bits of the PTPSR register are used for Precision Timer Prescaler Selection, and all bits. This bit is writable only once out of reset.

22.3.2.7 Timer Toggle On Overflow Register 1 (TTOV)

Module Base + 0x0007

	7	6	5	4	3	2	1	0
R W	TOV7	TOV6	TOV5	TOV4	TOV3	TOV2	TOV1	TOV0
Reset	0	0	0	0	0	0	0	0

Figure 22-13. Timer Toggle On Overflow Register 1 (TTOV)

Read: Anytime

Write: Anytime

Table 22-7. TTOV Field Descriptions

Field	Description
7:0 TOV[7:0]	 Toggle On Overflow Bits — TOVx toggles output compare pin on overflow. This feature only takes effect when in output compare mode. When set, it takes precedence over forced output compare but not channel 7 override events. 0 Toggle output compare pin on overflow feature disabled. 1 Toggle output compare pin on overflow feature enabled.



-

SEC[1:0]	Status of Security
00	SECURED
01	SECURED ⁽¹⁾
10	UNSECURED
11	SECURED

Table 25-12. Flash Security States

1. Preferred SEC state to set MCU to secured state.

The security function in the Flash module is described in Section 25.5.

25.3.2.3 Flash CCOB Index Register (FCCOBIX)

Offset Module Base + 0x0002

The FCCOBIX register is used to index the FCCOB register for Flash memory operations.



Figure 25-7. FCCOB Index Register (FCCOBIX)

CCOBIX bits are readable and writable while remaining bits read 0 and are not writable.

 Table 25-13. FCCOBIX Field Descriptions

Field	Description
2–0 CCOBIX[1:0]	Common Command Register Index — The CCOBIX bits are used to select which word of the FCCOB register array is being read or written to. See Section 25.3.2.11, "Flash Common Command Object Register (FCCOB)," for more details.

25.3.2.4 Flash ECCR Index Register (FECCRIX)

The FECCRIX register is used to index the FECCR register for ECC fault reporting.



Figure 25-8. FECCR Index Register (FECCRIX)

ECCRIX bits are readable and writable while remaining bits read 0 and are not writable.



Chapter 27 512 KByte Flash Module (S12XFTM512K3V1)

Revision Number	Revision Date	Sections Affected	Description of Changes				
V01.09	14 Nov 2007	27.5.2/27-1075 27.4.2/27-1051 27.4.2.8/27- 1057	 Changed terminology from 'word program' to "Program P-Flash' in the BDM unsecuring description, Section 27.5.2 Added requirement that user not write any Flash module register during execution of commands 'Erase All Blocks', Section 27.4.2.8, and 'Unsecure Flash', Section 27.4.2.11 Added statement that security is released upon successful completion of command 'Erase All Blocks', Section 27.4.2.8 				
V01.10	19 Dec 2007	27.4.2/27-1051	- Corrected Error Handling table for Full Partition D-Flash, Partition D-Flash, and EEPROM Emulation Query commands				
V01.11	25 Sep 2009	27.1/27-1016 27.3.2.1/27- 1027 27.4.2.4/27- 1054 27.4.2.7/27- 1056 27.4.2.12/27- 1060 27.4.2.12/27- 1060 27.4.2.12/27- 1060 27.4.2.20/27- 1069 27.3.2/27-1025 27.3.2.1/27- 1027 27.4.1.2/27- 1046 27.6/27-1075	 Clarify single bit fault correction for P-Flash phrase Expand FDIV vs OSCCLK Frequency table Add statement concerning code runaway when executing Read Once command from Flash block containing associated fields Add statement concerning code runaway when executing Program Once command from Flash block containing associated fields Add statement concerning code runaway when executing Verify Backdoor Access Key command from Flash block containing associated fields Add statement concerning code runaway when executing Verify Backdoor Access Key command from Flash block containing associated fields Relate Key 0 to associated Backdoor Comparison Key address Change "power down reset" to "reset" Add ACCERR condition for Disable EEPROM Emulation command The following changes were made to clarify module behavior related to Flash register access during reset sequence and while Flash commands are active: Add caution concerning register writes while command is active Writes to FCLKDIV are allowed during reset sequence while CCIF is clear Add caution concerning register writes while command is active Writes to FCCOBIX, FCCOBHI, FCCOBLO registers are ignored during reset sequence 				

Table 27-1. Revision History



28.4 Functional Description

28.4.1 Flash Command Operations

Flash command operations are used to modify Flash memory contents or configure module resources for EEE operation.

The next sections describe:

- How to write the FCLKDIV register that is used to generate a time base (FCLK) derived from OSCCLK for Flash program and erase command operations
- The command write sequence used to set Flash command parameters and launch execution
- Valid Flash commands available for execution

28.4.1.1 Writing the FCLKDIV Register

Prior to issuing any Flash program or erase command after a reset, the user is required to write the FCLKDIV register to divide OSCCLK down to a target FCLK of 1 MHz. Table 28-9 shows recommended values for the FDIV field based on OSCCLK frequency.

NOTE

Programming or erasing the Flash memory cannot be performed if the bus clock runs at less than 1 MHz. Setting FDIV too high can destroy the Flash memory due to overstress. Setting FDIV too low can result in incomplete programming or erasure of the Flash memory cells.

When the FCLKDIV register is written, the FDIVLD bit is set automatically. If the FDIVLD bit is 0, the FCLKDIV register has not been written since the last reset. If the FCLKDIV register has not been written, any Flash program or erase command loaded during a command write sequence will not execute and the ACCERR bit in the FSTAT register will set.

28.4.1.2 Command Write Sequence

The Memory Controller will launch all valid Flash commands entered using a command write sequence.

Before launching a command, the ACCERR and FPVIOL bits in the FSTAT register must be clear (see Section 28.3.2.7) and the CCIF flag should be tested to determine the status of the current command write sequence. If CCIF is 0, the previous command write sequence is still active, a new command write sequence cannot be started, and all writes to the FCCOB register are ignored.

CAUTION

Writes to any Flash register must be avoided while a Flash command is active (CCIF=0) to prevent corruption of Flash register contents and Memory Controller behavior.

No.	с	Characteristic ⁽¹⁾	Symbol	1 stretch cycle		2 stretch cycles		3 stretch cycles		Unit
				Min	Max	Min	Max	Min	Max	
-	-	Internal cycle time	t _{cyc}	20	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	20	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	20	∞	ns
1	-	Cycle time	t _{cyce}	40	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	60	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	80	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	ns
2	D	Pulse width, E high	PW _{EH}	9	11	9	11	9	11	ns
3	D	E falling to sampling E rising	t _{EFSR}	28	32	48	52	68	72	ns
4	D	Address delay time	t _{AD}	refer to	o table	refer to	o table	refer to table		ns
5	D	Address hold time	t _{AH}	Table	A-32	Table	A-32	Table A-32		ns
6	D	IVD delay time ⁽²⁾	t _{IVDD}							ns
7	D	IVD hold time	t _{IVDH}							ns
8	D	Read data setup time	t _{DSR}							ns
9	D	Read data hold time	t _{DHR}						ns	
10	D	Write data delay time	t _{DDW}					ns		
11	D	Write data hold time	t _{DHW}							ns
12	D	Read/write data delay time ⁽³⁾	t _{RWD}							ns

Typical Supply and Silicon, Room Temperature Only
 Includes also ACCx, IQSTATx
 Includes LSTRB



0x0280–0x02BF MSCAN (CAN4) Map (continued)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x028D	CAN4MISC	R	0	0	0	0	0	0	0	BOHOLD
		W R	BXEBB7	BXEBB6	BXEBB5	BXEBB4	BXEBB3	BXEBB2	BXEBB1	BXEBB0
0x028E	CAN4RXERR	W								
0x028F	CAN4TXERR	R	TXERR7	TXERR6	TXERR5	TXERR4	TXERR3	TXERR2	TXERR1	TXERR0
0x0290	CAN4IDAR0	W R	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
0x0291	CAN4IDAR1	W R	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
0x0292	CAN4IDAR2	R	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
0x0293	CAN4IDAR3	R W	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
0x0294	CAN4IDMR0	R W	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
0x0295	CAN4IDMR1	R W	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
0x0296	CAN4IDMR2	R W	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
0x0297	CAN4IDMR3	R W	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
0x0298	CAN4IDAR4	R W	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
0x0299	CAN4IDAR5	R W	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
0x029A	CAN4IDAR6	R W	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
0x029B	CAN4IDAR7	R W	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
0x029C	CAN4IDMR4	R W	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
0x029D	CAN4IDMR5	R W	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
0x029E	CAN4IDMR6	R W	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
0x029F	CAN4IDMR7	R W	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
0x02A0– 0x02AF	CAN4RXFG	R		(See Detail	FORE ed MSCAN	GROUND F	RECEIVE BU	FFER Transmit Bu	iffer Layout)	
0,00000		W			FODE			IEEED		
0x02B0- 0x02BF	CAN4TXFG	W		FOREGROUND TRANSMIT BUFFER (See Detailed MSCAN Foreground Receive and Transmit Buffer Layout)						

ndix E Detailed Register Address Map

0x0300–0x0327 Pulse Width Modulator 8-Bit 8-Channel (PWM) Map (Sheet 2 of 3)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x030A	PWMSCNTA	R	0	0	0	0	0	0	0	0
		W								
0x030B	PWMSCNTB	R	0	0	0	0	0	0	0	0
		W								
0x030C	PWMCNT0	R	Bit 7	6	5	4	3	2	1	Bit 0
		W	0	0	0	0	0	0	0	0
0x030D	PWMCNT1	R	Bit 7	6	5	4	3	2	1	Bit 0
		W	0	0	0	0	0	0	0	0
0x030E	PWMCNT2	ĸ		6	5	4	3	2	1	Bit 0
		VV	0	0		0	0	0	0	0
0x030F	PWMCNT3	ĸ		0	5	4	3	2	1	Bit U
			Dit 7	0	5	0	0	0	1	U Bit O
0x0310	PWMCNT4	n W		0	5	4	3	2	0	
		B	Bit 7	6	5	4	3	2	1	Bit 0
0x0311	PWMCNT5	w	0	0	0		0	0	0	0
		B	Bit 7	6	5	4	3	2	1	Bit 0
0x0312	PWMCNT6	w	0	0	0	0	0	0	0	0
0x0313	PWMCNT7	R	Bit 7	6	5	4	3	2	1	Bit 0
		w	0	0	0	0	0	0	0	0
0.0014		R	D:+ 7							D:1 0
0x0314	PWMPER0	w	Bit 7	6	5	4	3	2	1	Bit 0
0x0315	PWMPER1	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x0316	PWMPER2	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x0317	PWMPER3	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x0318	PWMPER4	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x0319	PWMPER5	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x031A	PWMPER6	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x031B	PWMPER7	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x031C	PWMDTY0	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x031D	PWMDTY1	R W	Bit 7	6	5	4	З	2	1	Bit 0
0x031E	PWMDTY2	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x031F	PWMDTY3	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x0320	PWMDTY4	R W	Bit 7	6	5	4	3	2	1	Bit 0